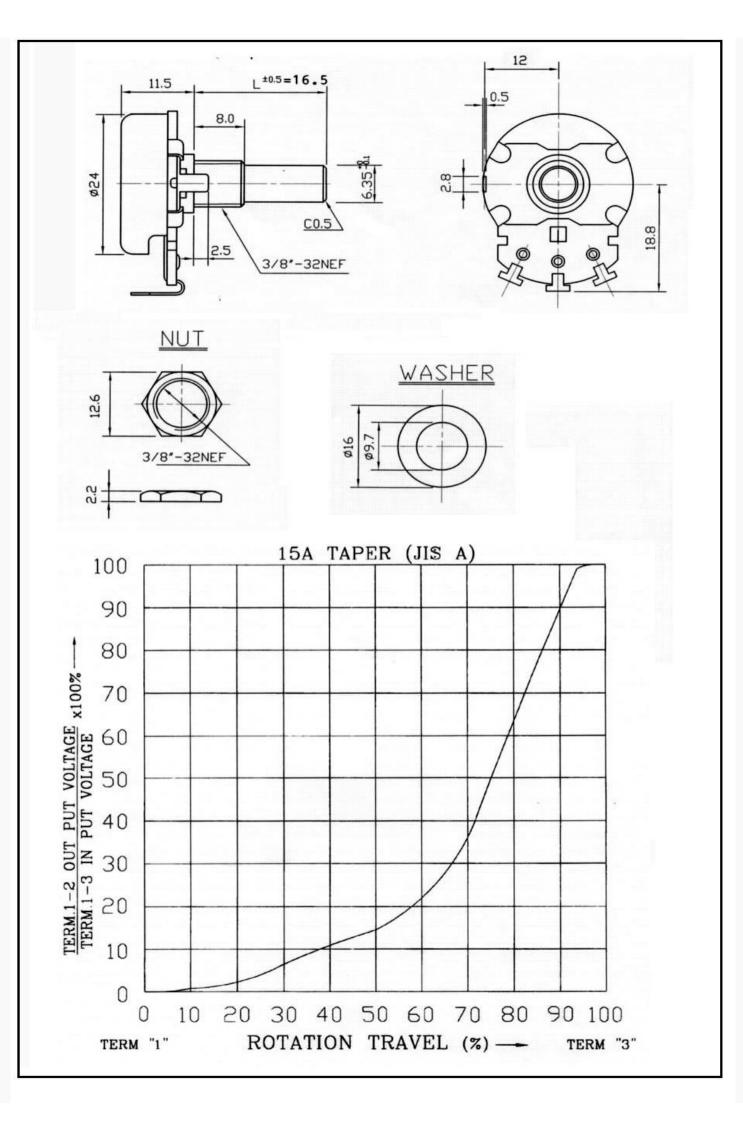
Common Specification of Lead-Free Soldering for Potentiometers

The specification below is based on testing results of 1.6mm thickness single layer printed circuit board.

- 1. For Manual Soldering:
 - 1-1 To be performed within 3 seconds at 350°C or below.
- 2. For Automated or Semi-Automated Soldering Equipments:
 - 2-1 Flux of 0.82 specific gravity, applied by foam fluxer, shall be used. Foam head shall be limited to the height which is half thickness of printed circuit board to be soldered. No flux should be allowed to run up onto resistive element board of potentiometer and the surface of printed circuit board.
 - 2-2 Regarding preheating, the entire flow duration should not exceed 2 minutes, and soldering surface temperature (undersurface of PCB) shall be settled within 100°C.
 - 2-3 Solder Dipping is to be performed within 4 seconds at 260°C or below.
- For potentiometer with centre detent or multiple detents, its shaft or lever should be settled in relevant detent position prior to soldering process.
- Regardless of soldering facility and method, solder dipping or solder smearing must not be carried out more than 1 time.

Remarks: This specification is not recommended for and applicable in reflow soldering.



CUSTOMER'S NAME	Tube Amp Doctor Musikhandles GmbH	NOTE
CUSTOMER'S PART NAME		
CUSTOMER'S DRAWING NO.		
1. MECHANICAL SPECI	FICATION	2. ELECTRICAL SPECIFICATION

I. MECHANICAL SPECIFICAL	ION						
1. OUTSIDE DIMENSION	append fig.						
2. TOTAL ROTATION ANGLE	degree	300 ±5°					
3. TOTAL TRAVEL STROKE	mm	±0.5					
4. NUT WIRING STRENGTH	twisting moment	less than 9 kg.cm					
5. SCREW TIGHTENING FORCE	torsional moment	less than kg.cm					
6. ROTATION TORQUE	speed 60 deg/sec.	20~200 g.cm					
7. SLIDING FORCE	speed 20mm/sec	g.cm					
8. SHAFT LEVER STRENGTH	pulling pushing	more than kg					
9. SHAFT LEVER WOBBLE	within mm (bending moment						
10. SHAFT LEVER STOP STRENGTH	more than 6 kg.cm (static load) / 60 sec					
	more than 500 g.cm / 1	0 ± 1 sec					
11. TERMINAL STRENGTH	soldering heat 300±5"C/3sec. 200g.cm/10 ±1sec						
	resist change within ± 2%						
12. CLICK POSITION & TORQUE	g.cm						
13. SWITCH WORKING ANGLE (STROKE)	degree (mm)						
14. SWITCH WORKING TORQUE (FORCE)	g.cm						
15. SWITCH CIRCUIT							

SHAFT

	ANGLE OF FLAT OR SLOT	DIMENSION			
MATERIAL	θ	M	L	F	T
ALUMINU M			16.5		

1. OVERALL RESISTANCE & TOLERANCE	termina	11-3		Ω± 30	%
2. TAP RESISTANCE & TOLERANCE	terminal 1-4			Ω±	%
3. RATED WATTAGE	temp 0~50°C			0.25	W
4. MAXIMUM WORKING VOLTAGE				250	V
5. RESISTANCE TAPER MEASURING POINT & TOLERANCE			A 50	0 %j	ooint %
6. RESIDUAL RESISTANCE	terminal 1	/3 side	less than	20/20	Ω
7. TAP RESIDUAL RESISTANCE	terminal 4 side		less than	100	Ω
8. SLIDE NOISE		The second second	less than	47	m\
9. INSULATION RESISTANCE	more than	100	MΩ(DC	500	V)
10. WITHSTAND VOLTAGE	AC	500	V	1 m	inute
II. TRACKING ERROR					
12. SWITCH CONTACT RESISTANCE	MΩ		less than	$m\Omega$	
13. SWITCH RATING					

3. USABLE TEMPERATURE RANGE: from -10°C to 70°C

TIMES

4. VR LIFE 15,000 ±